AN7379NSH

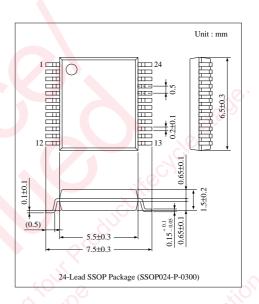
Dolby* B-type Noise Reduction Decoder for 1.5V Headphone Stereo

■ Overview

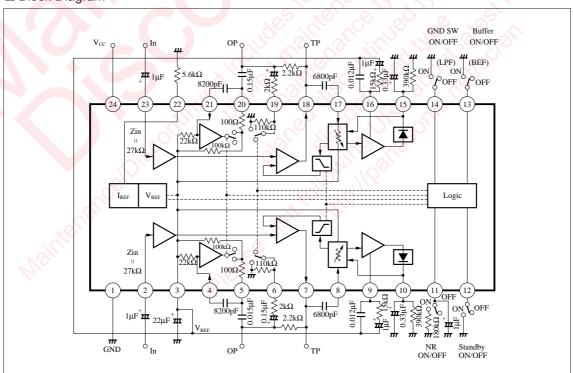
The AN7379NSH is an IC for Dolby B-type noise reduction playback suitable for 1.5V headphone stereo and incorporates multi-purpose buffer amp., GND switch and stand-by function in a single chip.

■ Features

- Operating voltage range: V_{CC}=1.0 to 3.6V
 Head room (Dolby Level +12dB) is guaranteed to 1.1V.
- Low consumption current : 1 total =3.6mA
- Small number of parts
- Buffer amplifier with switches, GND switch pin
- Stand-by switches greatly saving the consumption current
- Small package: 0.5mm pitch 24-lead SOP type
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■ Block Diagram



■ Pin Description

Pin No.	Pin Name	Pin No.	Pin Name
1	GND	13	Buffer Amp. ON/OFF
2	NR Decode Input	14	GND Switch ON/OFF
3	V_{REF}	15	Control Voltage
4	Buffer Amp. Input	16	Weighting Amp. Filter
5	Buffer Amp. Output	17	Side Chain Filter
6	GND Switch	18	NR Decode Output
7	NR Decode Output	19	GND Switch
8	Side Chain Filter	20	Buffer Amp. Output
9	Weighting Amp. Filter	21	Buffer Amp. Input
10	Control Voltage	22	I _{REF}
11	NR ON/OFF	23	NR Decode Input
12	Stand-by ON/OFF	24	V _{CC}

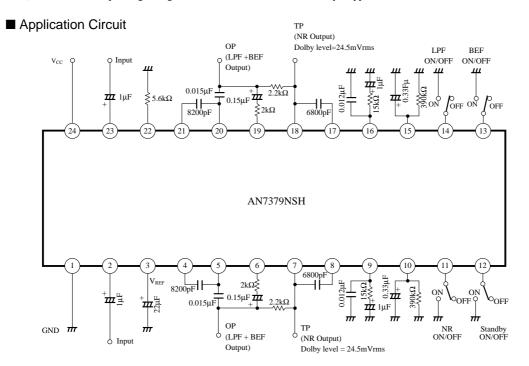
■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply Voltage	V _{CC}	4.5	V
Supply Current	I_{CC}	10	mA
Power Dissipation (Ta =75°C)	P _D	45	mW
Operating Ambient Temperature	T_{opr}	<i>−</i> 25 ~ + 75	°C
Storage Temperature	$T_{ m stg}$	-55 ~ + 125	°C

■ Recommended Operating Range (Ta= 25°C)

Parameter	Symbol	Range			
Operating Supply Voltage Range	V_{CC}	1V ~ 3.6V			

Note) The minimum operating voltage to conform to the standards of Dolby B type NR is 1.1V.



■ Electrical Characteristics (Ta=25°C, V_{CC}= 1.2V, Dolby Reference Level; 24.5mVrms (–30dBm) at TP)

Parameter			G 1 1			Condition				4		TT '
			Symbol	NR	LPF	BPF	f Hz	Others	min.	typ.	max.	Unit
	Standby OFF		I _{CC1}	OFF	OFF	OFF	_	No signals	2.8	3.8	5.0	mA
Total Circuit Current	Standby OFF		I _{CC2}	ON	OFF	OFF	_	No signals	2.8	3.9	5.1	mA
Current	Standby ON		I _{CC3}	OFF	OFF	ON		No signals		0	0.5	mA
Standard Input	Standard Input Level Note 1)		Vin	OFF	OFF	OFF	1k	$V_O = 24.5 \text{mVrms}$	20	23	26	mVrms
Channel Balance	Channel Balance			OFF	OFF	OFF	1k	Channel Ratio	-1	0	-1	dB
(1) (2) NR–Decode Characteristics Note 2) (3)		NRD1	ON	OFF	OFF	10k	V _{in} = -29.6dB Theoretical NRD = V _O +40dB	-2	0	2	dB	
		(2)	NRD2	ON	OFF	OFF	1k	$V_{in} = -23.9 dB$ Theoretical NRD $= V_O +30 dB$	-2	0	2	dB
		(3)	NRD3	ON	OFF	OFF	1k	$V_{\rm in}\!=\!-15.8 dB$ Theoretical NRD $=V_{\rm O}\!+\!20 dB$	-2.5	0	2.5	dB
			NRD4	ON	OFF	OFF	10k	V _{in} = -17.4dB Theoretical NRD = V _O +20dB	-2.5	0	2.5	dB
			NRD5	ON	OFF	OFF	10k	$V_{in} = 0.4 dB$ Theoretical NRD = $V_0 dB$	-2	0	2	dB
Total Harmonic	Total Harmonics (1)		THD1	OFF	ON	ON	1k	$V_{in} = +10dB$		0.2	0.5	%
		(2)	THD2	ON	OFF	OFF	1k	$V_{in} = +10dB$		0.3	0.8	%
Signal Handling Note 3) (3		(3)	THD3	ON	OFF	OFF	1k	$V_{in} = +12dB$		0.3	1.0	%
S/N Ratio Note 4)		S/N	ON	OFF	OFF		$\begin{array}{l} R_{\rm g}\!=\!5.6k\Omega \\ CCIR/ARM- \\ Filter \end{array}$	70	72		dB	
Filter Characteristics Note 5) (1) (2) (3)		G _{V1}	OFF	OFF	OFF	1k	$V_{in} = 0dB$	-1.5	- 0.5	0.5	dB	
		(2)	G_{V2}	OFF	ON	ON	1k	$V_{in} = 0dB$	-8	- 6.5	- 5	dB
		(3)	G _{V3}	OFF	ON	ON	5.5k	$V_{in} = 0dB$	-20	-17	-12	dB
Channel	NR : OFF		CT1	ON	OFF	OFF	1k	$V_{in} = 0dB$		50		dB
Crosstalk	NR : ON		CT1	OFF	OFF	OFF	1k	$V_{in} = 0dB$		50		dB

Adjust input level for output level equal to 24.5 mVrms, and set the reference input level to 0dB. Output level as compared with Standard 0dB = 24.5 mVrms..Measurement point : TP Note 1)

Note 2)

Measurement point : OP Measurement point : TP Note 3)

Note 5) Measurement point as compared with 24.5mVrms: Output level at OP

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